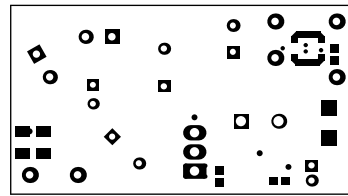
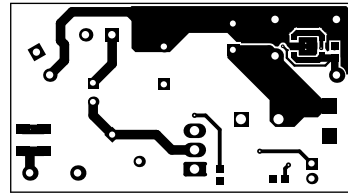


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 8/5/2015	4:21:56 PM	TEXAS INSTRUMENTS

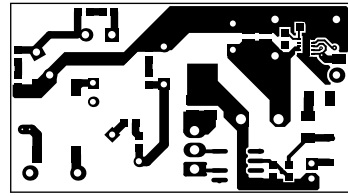
String



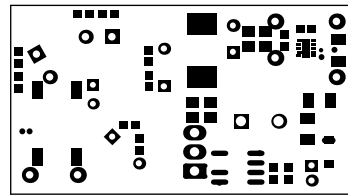
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 8/5/2015	4:21:57 PM	TEXAS INSTRUMENTS



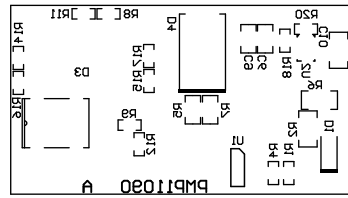
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 8/5/2015	4:21:58 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 8/5/2015	4:21:59 PM	TEXAS INSTRUMENTS

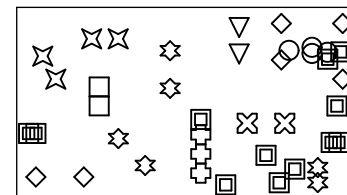


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/5/2015 4:21:59 PM	TEXAS INSTRUMENTS	

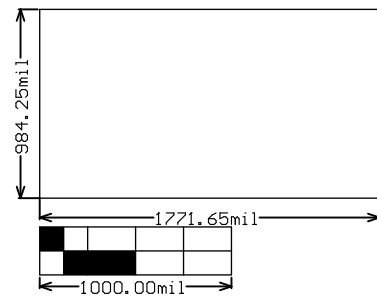


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 8/5/2015	4:22:00 PM	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	4	7.87mil (0.200mm)	PTH	Round
■	12	10.00mil (0.254mm)	PTH	Round
□	2	31.00mil (0.787mm)	PTH	Round
▽	2	33.00mil (0.838mm)	PTH	Round
☆	6	33.46mil (0.850mm)	PTH	Round
✕	4	39.37mil (1.000mm)	PTH	Round
◇	6	40.00mil (1.016mm)	PTH	Round
⊕	3	50.00mil (1.270mm)	PTH	Round
⊗	2	54.00mil (1.372mm)	PTH	Round
	41 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 8/5/2015	4:22:01 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP11090	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 8/5/2015	4:22:02 PM	TEXAS INSTRUMENTS



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